

Státní tiskárna cenin, s. p. Růžová 943/6, Nové Město, 110 00 Praha 1 Czech Republic Represented by: Tomáš Hebelka, MSc, CEO

(hereinafter referred to as "Contracting Authority")

EXPLANATION OF TENDER DOCUMENTATION – VIII.

The Contracting Authority of the over-threshold public contract called "**Supply of Contact Chip Modules // Dodávky kontaktních čipových modulů**" being awarded in an open procedure pursuant to Act No. 134/2016 Coll., On Public Procurement, as amended (hereinafter referred to as "Act"), hereby explains the tender documentation in accordance with Sec. 98 of the Act.

Question No. 1:

We have a small technical question. According to the Tender Documentation you require a technical specification, see below with the use of the word "<u>chip</u>". I believe that the customer's intention was the request for technical details of the <u>contact module</u> (apart from point Nr. 1), its dimensions, recommendations for milling into the card etc.

Thank you for the clarification.

"13.5 Description of technical solution, technical documentation"

In accordance with the Sec. 37(1)(b) of the Act the Contracting Authority requires

the participant's tender to include the following specification and documentation

regarding the offered technical solution, which shall be in accordance with all

requirements of the Contracting Authority in this public contract, as a part of

determined technical conditions of participation:

1. Description of offered technical solution, i.e. of the <u>Chip</u>, which shall be drafted minimally in a detail, that the Contracting Authority may verify that all the requirements stated in the Annex 1a of the Draft Contract are fulfilled.

Among others it shall be evident from this document that the solution offered by the Contractor in its tender is identical to the "IAS Classic v 5.2 on MultiApp V5.0" solution or not (according to Art. 9.3 and 9.5 hereof).

2. <u>Chip technical drawing</u>, with a design of Chip line with measurements

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including thickness and design of front and back side of the Chip. The drawing shall contain a recommended punching size and maximum potting surface as well.

3. <u>Chip</u> datasheet and, if available, other documentation with detailed technical description of the <u>Chip</u>

4. <u>Chip</u> operating system datasheet and, if available, other documentation with technical specification of the operating system

of the <u>Chip</u>

5. Standard conditions of use and storage conditions of <u>Chip</u> The Participant has the obligation to submit the standard conditions of use and storage conditions of Contractor, if they are different from the storage conditions of the Contracting Authority in Annex No. 2a of Draft Contract.

6. EU list of QSCD devices

The Chip (chip, operating system and PKI applet(s)) may be listed as a QSCD device on EU list of QSCD devices: https://eidas.ec.europa.eu/efda/notificationtool/#/screen/browse/list/QSCD_SSCD The Contractor shall prove such a optional requirement in a form of a written affidavit of the Contractor, where the Contractor shall state a name of the Chip which is being offered within the Public Contract and the tender, so the Contractor Authority shall verify that the Chip is listed as a QSCD device on EU list of QSCD devices."

Answer No. 1:

The Contracting Authority states that in Art. 3.1 of the Tender Documentation, the abbreviation "Chip" or "Chips" has been introduced to replace the subject of performance, i.e., "Contact chip modules with operating system based on platform Java Card and Global Platform including on board applications for the purpose of the further processing of identification cards, pursuant to the Technical specification, which is Annex No. 1a of the Draft Contract". The Contracting Authority therefore considers that "Chip" or "Chips" in the above-mentioned texts of the Tender Documentation are understandable.



The Contracting Authority states that it has decided to answer this question beyond its obligations, as the question was received after the deadline for possible requests for explanation of the Tender Documentation.

The Contracting Authority does not consider this explanation as alteration or supplementation of the tender documentation whose nature would demand extension of the time limit for the tender submission in accordance with Sec. 99 (2) of the Act, since the Contracting Authority does not alter the tender conditions.

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In Prague, dated as per the electronic signature

Mgr. Zuzana Drahokoupil Šenoldová Head of Public Procurement for the Contracting Authority Státní tiskárna cenin, s. p.